

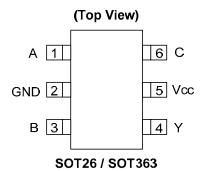
Description

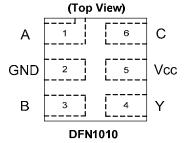
The 74LVC1G11 is a single 3-input positive AND gate with a standard totem pole output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

$$Y = A \bullet B \bullet C$$
 or $Y = \overline{A} + \overline{B} + \overline{C}$

Pin Assignments





Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Exceeds JESD 22
 - o 200-V Machine Model (A115-A)
 - o 2000-V Human Body Model (A114-A)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- SOT26, SOT363, and DFN1010: Available in "Green"
 Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
 - o PCs, networking, notebooks, netbooks, PDAs
 - o Computer peripherals, hard drives, CD/DVD ROM
 - o TV, DVD, DVR, set top box
 - o Cell Phones, Personal Navigation / GPS
 - o MP3 players ,Cameras, Video Recorders

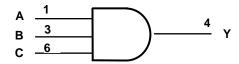
Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.



Pin Descriptions

Pin Name	Description
A	Data Input
GND	Ground
В	Data Input
Y	Data Output
Vcc	Supply Voltage
С	Data Input

Logic Diagram



Function Table

	Inputs						
Α	В	С	Υ				
Н	Н	Н	Н				
L	Х	Х	L				
Х	L	Х	L				
Х	Х	L	L				

Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
I _{OK}	Output Clamp Current	-50	mA
Io	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
T _J	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Recommended Operating Conditions (Note 3)

Symbol		Parameter	Min	Max	Unit
	On a ratio a Malta a a	Operating	1.65	5.5	V
V_{CC}	Operating Voltage	Data retention only	1.5		V
		V _{CC} = 1.65 V to 1.95 V	0.65 X V _{CC}		
V /	Lligh level lancet Valtage	V _{CC} = 2.3 V to 2.7 V	1.7		V
V_{IH}	High-level Input Voltage	V _{CC} = 3 V to 3.6 V	2		V
		V _{CC} = 4.5 V to 5.5 V	0.7 X V _{CC}		
		V _{CC} = 1.65 V to 1.95 V		0.35 X V _{CC}	
	Lave lavel in motor like an	V _{CC} = 2.3 V to 2.7 V		0.7	
V_{IL}	Low-level input voltage	V _{CC} = 3 V to 3.6 V		0.8	V
		V _{CC} = 4.5 V to 5.5 V		0.3 X V _{CC}	
Vı	Input Voltage		0	5.5	V
Vo	Output Voltage		0	Vcc	V
		V _{CC} = 1.65 V		-4	
		V _{CC} = 2.3 V		-8	
I_{OH}	High-level output current	V 2 V		-16	mA
		$V_{CC} = 3 V$		-24	
		V _{CC} = 4.5 V		-32	
		V _{CC} = 1.65 V		4	
		V _{CC} = 2.3 V		8	
I_{OL}	Low-level output current	V 2 V		16	mA
		$V_{CC} = 3 V$		24	
		V _{CC} = 4.5 V		32	
		V _{CC} = 1.8 V ± 0.15V, 2.5 V ± 0.2 V		20	
$\Delta t/\Delta V$	Input transition rise or fall rate	V _{CC} = 3.3 V ± 0.3 V		10	ns/V
		V _{CC} = 5 V ± 0.5 V		5	
T _A	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at Vcc or Ground.



Electrical Characteristics $T_A=-40$ °C to 85 °C (All typical values are at Vcc = 3.3V, $T_A=25$ °C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур.	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} – 0.1			
		I _{OH} = -4mA	1.65V	1.2			
V	High Level Output	$I_{OH} = -8mA$	2.3V	1.9			V
V _{OH}	Voltage	I _{OH} = -16mA	2)/	2.4			V
		I _{OH} = -24mA	3V	2.3			
		I _{OH} = -32mA	4.5V	3.8			
		I _{OL} = 100μA	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.45	
V	High lavellanest Valtages	I _{OL} = 8mA	2.3V			0.3	V
V _{OL}	High-level Input Voltage	I _{OL} = 16mA	2)/			0.4	V
		I _{OL} = 24mA	3V			0.55	
		I _{OL} = 32mA	4.5V			0.55	
l _l	Input Current	V _I = 5.5 V or GND	0 to 5.5V			± 5	μA
l _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 5.5V$	0			± 10	μΑ
Icc	Supply Current	V _I = 5.5V of GND I _O =0	1.65V to 5.5V			10	μΑ
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6 V	3 V to 5.5V			500	μΑ



Electrical Characteristics $T_A=-40$ °C to 125 °C (All typical values are at Vcc = 3.3V, $T_A=25$ °C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур.	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} - 0.1			
		$I_{OH} = -4mA$	1.65V	0.95			
\	High Level Output	$I_{OH} = -8mA$	2.3V	1.7			V
V _{OH}	Voltage	I _{OH} = -16mA	- 3V	1.9			V
		I _{OH} = -24mA	3 V	2.0			
		$I_{OH} = -32mA$	4.5V	3.4			
		I _{OL} = 100μA	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.70	
	High Javal Innut Valtage	I _{OL} = 8mA	2.3V			0.45	V
V _{OL}	High-level Input Voltage	I _{OL} = 16mA	2)./			0.60	V
		I _{OL} = 24mA	- 3V			0.80	
		$I_{OL} = 32mA$	4.5V			0.80	
I _I	Input Current	V _I = 5.5 V or GND	0 to 5.5V			± 20	μA
I _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 5.5V$	0			± 20	μA
Icc	Supply Current	V _I = 5.5V of GND I _O =0	1.65V to 5.5V			40	μA
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6 V	3 V to 5.5V			5000	μA
Ci	Input Capacitance	$V_i = V_{CC} - \text{ or GND}$	3.3		4		pF
		SOT26			166		
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOT363	(Note 4)		333		°C/W
	Junction-to-Ambient	DFN1010			231		
		SOT26			46		
θ_{JC}	Thermal Resistance Junction-to-Case	SOT363	(Note 4)		102		°C/W
	Junction-to-Case	DFN1010	1		TBD		1

Notes: 4. Test condition for SOT26, SOT363 and DFN1010 : Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Switching Characteristics

 T_A =-40 °C to 85 °C , CL = 15pF (see Figure 1)

Parameter	rameter From TO (Input) (OUTPUT)		Vcc = 1.8 V ± 0.15V		Vcc = 2.5 V ± 0.2V		Vcc = 3.3 V ± 0.3V		Vcc = 5 V ± 0.5V		Unit
		(ООТРОТ)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	15.2	0.7	5.6	0.7	4.1	0.7	3.1	ns

 T_A =-40 °C to 85 °C , CL = 30 or 50pF (see Figure 2)

Parameter	From		Vcc = 1.8 V ± 0.15V		Vcc = 2.5 V ± 0.2V		Vcc = 3.3 V ± 0.3V		Vcc = 5 V ± 0.5V		Unit
	(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	17.2	0.7	6.2	0.7	4.9	0.7	3.5	ns

 T_A =-40 °C to 125 °C , CL = 15 pF (see Figure 1)

Parameter	From	_		то	Vcc = ± 0.	1.8 V 15V	Vcc = ± 0	2.5 V .2V	Vcc = ± 0	3.3 V .3V		= 5 V).5V	Unit
	(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max			
t _{pd}	Any	Υ	1.0	18.3	0.7	6.7	0.7	4.9	0.7	3.7	ns		

 T_A =-40 °C to 125 °C , CL = 30 or 50pF (see Figure 2)

Parameter	From		Vcc = 1.8 V ± 0.15V		Vcc = 2.5 V ± 0.2V		Vcc = 3.3 V ± 0.3V		Vcc = 5 V ± 0.5V		Unit
	(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Υ	1.0	20.7	0.7	7.5	0.7	5.9	0.7	4.2	ns

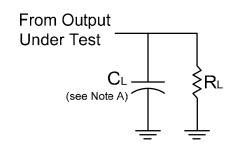
Operating Characteristics

 $T_A = 25$ °C

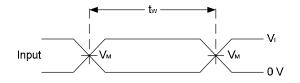
Parameter		Test	Vcc = 1.8 V	Vcc = 2.5 V	Vcc = 3.3 V	Vcc = 5 V	Unit
	raiailletei	Conditions	TYP	TYP	TYP	TYP	Oilit
C _{pd}	Power dissipation capacitance	f = 10 MHz	17	18	19	22	pF



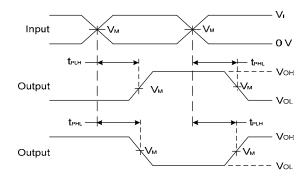
Parameter Measurement Information



Ves	In	puts	V		
Vcc	VI	t _r /t _f	V_{M}	C _L	R_L
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	15pF	1ΜΩ
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	15pF	1ΜΩ
3.3V±0.3V	3V	≤2.5ns	1.5V	15pF	1ΜΩ
5V±0.5V	V _{CC}	≤2.5ns	V _{CC} /2	15pF	1ΜΩ



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

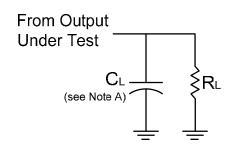
Notes:

- A. Includes test lead and test apparatus capacitance.
- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
 C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

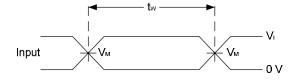
Figure 1. Load Circuit and Voltage Waveforms



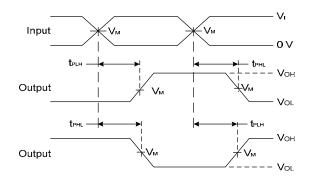
Parameter Measurement Information (Continued)



Vcc	Inputs		V	C ₁	В
	VI	t _r /t _f	V _M	O _L	R_L
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1ΚΩ
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
3.3V±0.3V	3V	≤2.5ns	1.5V	50pF	500Ω
5V±0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50pF	500Ω



Voltage Waveform Pulse Duration



Voltage Waveform
Propagation Delay Times
Inverting and Non Inverting Outputs

Notes:

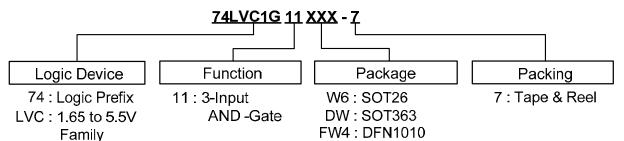
- A. Includes test lead and test apparatus capacitance.
- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

Figure 2. Load Circuit and Voltage Waveforms



SINGLE 3 INPUT POSITIVE AND GATE

Ordering Information



1G : One gate

Device	Package	Packaging (Note 7)	7" Tape and Reel		
Device	Code		Quantity	Part Number Suffix	
74LVC1G11W6-7	W6	SOT26	3000/Tape & Reel	-7	
74LVC1G11DW-7	DW	SOT363	3000/Tape & Reel	-7	
74LVC1G11FW4-7	FW4	DFN1010	5000/Tape & Reel	-7	

Notes: 7. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Marking Information

(1) SOT26, SOT363

5 4 XX: Identification code
Y: Year 0~9
W: Wook: A~7: 1~36

<u>XX Y W X</u> W: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents

52 and 53 week
 1 2 3 X: A~Z: Internal Code

Part Number	Package	Identification Code
74LVC1G11W6	SOT26	TV
74LVC1G11DW	SOT363	TV



Marking Information (Continued)

(2) DFN1010

(Top View)



 $\frac{XX}{Y}$: Identification Code $\frac{X}{Y}$: Year : 0~9

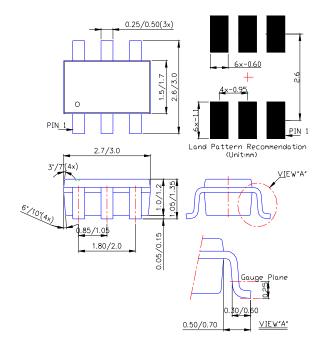
\overline{\tilde{W}}: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents

52 and 53 week X: A~Z: Internal code

Part Number	Package	Identification Code
74LVC1G11FW4	DFN1010	TV

Package Outline Dimensions (All Dimensions in mm)

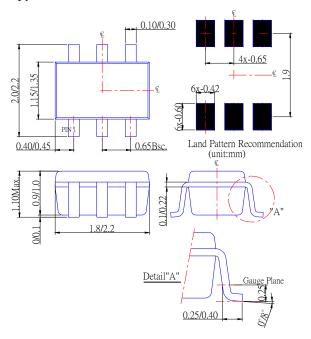
(1) Package Type: SOT26



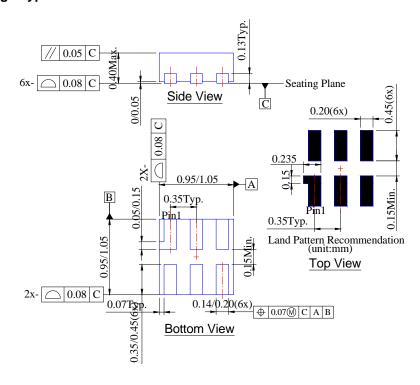


Package Outline Dimensions (All Dimensions in mm) (Continued)

(2) Package Type: SOT363



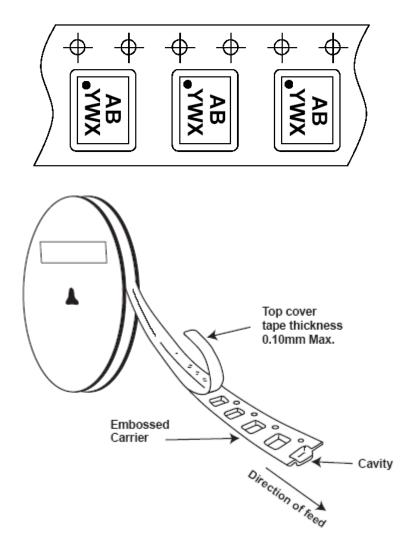
(3) Package Type: DFN1010





Taping Orientation (Note 8)

For DFN1010



Notes: 8. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf



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